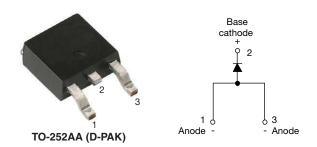
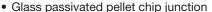


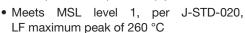
High Voltage Surface Mount Input Rectifier Diode, 8 A



PRODUCT SUMMARY						
Package	TO-252AA (D-PAK)					
I _{F(AV)}	8 A					
V _R	1600 V					
V _F at I _F	1.1 V					
I _{FSM}	150 A					
T _J max.	150 °C					
Diode variation	Single die					

FEATURES







 Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

RoHS COMPLIANT

APPLICATIONS

- · Input rectification
- Vishay Semiconductors switches and output rectifiers which are available in identical package outlines

DESCRIPTION

The VS-8EWS16SPbF rectifier high voltage series has been optimized for very low forward voltage drop, with moderate leakage. The glass passivation technology used has reliable operation up to 150 °C junction temperature.

The **high reverse voltage** range available allows design of input stage primary rectification with **outstanding voltage surge** capability.

OUTPUT CURRENT IN TYPICAL APPLICATIONS								
APPLICATIONS SINGLE-PHASE BRIDGE THREE-PHASE BRIDGE UNIT								
NEMA FR-4 or G10 glass fabric-based epoxy with 4 oz. (140 μm) copper	1.2	1.6						
Aluminum IMS, R _{thCA} = 15 °C/W	2.5	2.8	Α					
Aluminum IMS with heatsink, R _{thCA} = 5 °C/W	5.5	6.5						

Note

T_A = 55 °C, T_J = 125 °C, footprint 300 mm²

MAJOR RATINGS AND CHARACTERISTICS								
SYMBOL	CHARACTERISTICS VALUES UNITS							
I _{F(AV)}	Sinusoidal waveform	8	Α					
V _{RRM}		1600	V					
I _{FSM}		150	Α					
V _F	8 A, T _J = 25 °C	1.10	V					
T _J		-40 to +150	°C					

VOLTAGE RATINGS								
PART NUMBER	V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} AT 150 °C mA					
VS-8EWS16SPbF	1600	1700	0.5					



ABSOLUTE MAXIMUM RATINGS								
PARAMETER	VALUES	UNITS						
Maximum average forward current	I _{F(AV)}	$T_C = 105$ °C, 180 ° conduction half sine wave	8					
Maximum peak one cycle		10 ms sine pulse, rated V _{RRM} applied	125	Α				
non-repetitive surge current	I _{FSM}	10 ms sine pulse, no voltage reapplied	150					
Maximum I ² t for fusing	I ² t	10 ms sine pulse, rated V _{RRM} applied	78	A ² s				
Maximum i-t for fusing	1-1	0 ms sine pulse, no voltage reapplied 110		A-S				
Maximum I²√t for fusing	I ² √t	t = 0.1 ms to 10 ms, no voltage reapplied	1100	A²√s				

ELECTRICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CO	NDITIONS	VALUES	UNITS		
Maximum forward voltage drop	V _{FM}	8 A, T _J = 25 °C		1.1	V		
Forward slope resistance	r _t	T _{.1} = 150 °C		20	mΩ		
Threshold voltage	V _{F(TO)}	1J = 150 C		0.82	V		
Maximum reverse leakage current	1	T _J = 25 °C	V _B = Rated V _{BBM}	0.05	mA		
Maximum reverse leakage current	I _{RM}	T _J = 150 °C	VR = nateu VRRM	0.50	IIIA		

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum junction and storage temperature range	T _J , T _{Stg}		-40 to +150	°C			
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	2.5	°C/W			
Typical thermal resistance, junction to ambient (PCB mount) (1)	R _{thJA}		62	0/11			
Approximate weight			1	g			
Approximate weight			0.03	OZ.			
Marking device		Case style TO-252AA (D-PAK)	8EW	S16S			

Note

 $^{^{(1)}}$ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W For recommended footprint and soldering techniques refer to application note #AN-994

www.vishay.com Vishay Semiconductors

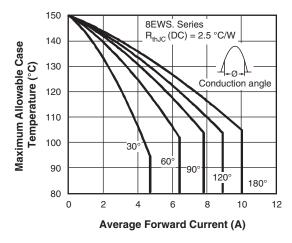


Fig. 1 - Current Rating Characteristics

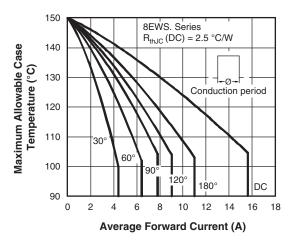


Fig. 2 - Current Rating Characteristics

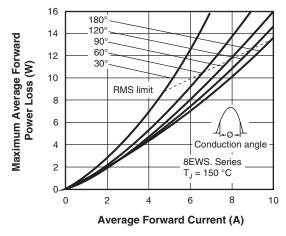


Fig. 3 - Forward Power Loss Characteristics

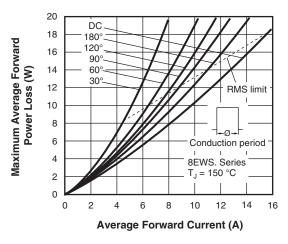


Fig. 4 - Forward Power Loss Characteristics

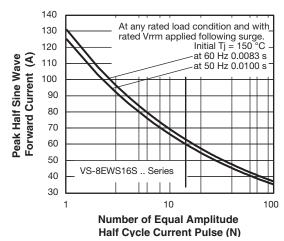


Fig. 5 - Maximum Non-Repetitive Surge Current

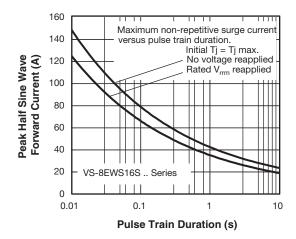


Fig. 6 - Maximum Non-Repetitive Surge Current

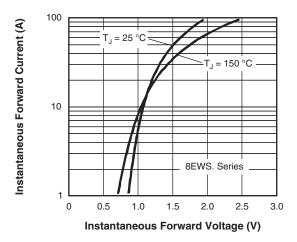


Fig. 7 - Forward Voltage Drop Characteristics

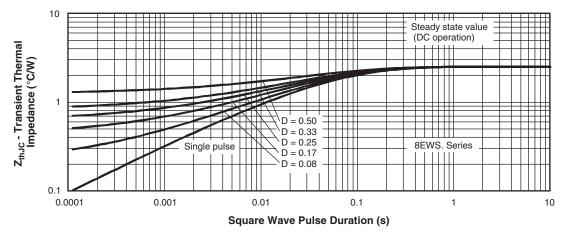
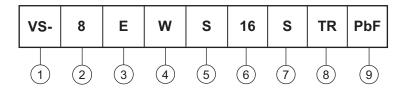


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Current rating (8 = 8 A)

3 - Circuit configuration:

E = single diode

4 - Package:

W = D-PAK

5 - Type of silicon:

S = standard recovery rectifier

6 - Voltage rating (16 = 1600 V)

S = surface mountable

TR = tape and reel

• TRR = tape and reel (right oriented)

• TRL = tape and reel (left oriented)

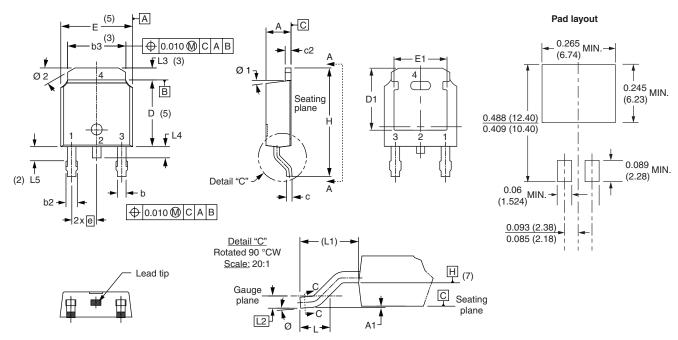
9 - PbF = lead (Pb)-free

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?95016				
Part marking information	www.vishay.com/doc?95059				
Packaging information	www.vishay.com/doc?95033				



D-PAK (TO-252AA)

DIMENSIONS in millimeters and inches



	SYMBOL -	MILLIM	IETERS	INCHES		NOTES		SYMBOL	MILLIN	
		MIN.	MAX.	MIN.	MAX.	NOTES		STIVIDUL	MIN.	
	Α	2.18	2.39	0.086	0.094			е	2.29	
	A1	-	0.13	-	0.005			Н	9.40	
	b	0.64	0.89	0.025	0.035			L	1.40	
	b2	0.76	1.14	0.030	0.045			L1	2.74	
	b3	4.95	5.46	0.195	0.215	3		L2	0.51	
	С	0.46	0.61	0.018	0.024			L3	0.89	
	c2	0.46	0.89	0.018	0.035			L4	-	
	D	5.97	6.22	0.235	0.245	5		L5	1.14	
	D1	5.21	-	0.205	-	3		Ø	0°	
	Е	6.35	6.73	0.250	0.265	5		Ø1	0°	
	E1	4.32	-	0.170	-	3		Ø2	25°	

SYMBOL	MILLIMETERS		INC	HES	NOTES
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29 BSC		0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74 BSC		0.108 REF.		
L2	0.51	BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0°	10°	0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC outline TO-252AA



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

单击下面可查看定价,库存,交付和生命周期等信息

>>Vishay(威世)